UWF

Chip Type, Low Impedance







- \bullet Chip type, low impedance temperature range up to +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU,(EU)2015/863).

• AEC-Q200 compliant. Please contact us for details.

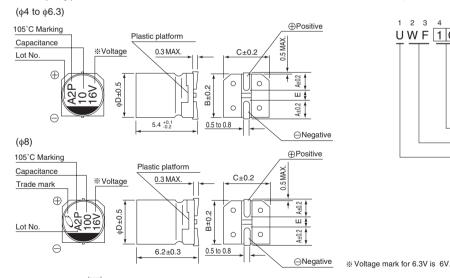
UWG Low Low Impedance UWF Low Impedance UWT



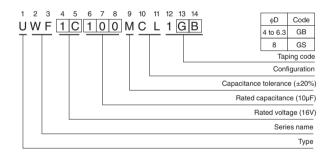
■Specifications

Item	Performance Characteristics									
Category Temperature Range	−55 to +105°C									
Rated Voltage Range	6.3 to 35V									
Rated Capacitance Range	1 to 220µF									
Capacitance Tolerance	±20% at 120Hz, 20°C									
Leakage Current	After 2 minutes' application of rated voltage at 20°C, leakage current is not more than 0.01CV or 3 (µA), whichever is greater.									
	Measurement frequency : 120Hz at 20°C									
Tangent of loss angle (tan δ)	Rated voltage (V)	6.3	10		16	2	25		35	
rangon or loss angle (tall s)	tan δ (MAX.)	0.22	0.19		0.16	0	.14		0.12	
	Measurement frequency : 120Hz									
Out in the Towns of the	Rated voltage (V)		6.	3	10	16		25	35	
Stability at Low Temperature	Impedance ratio	Z-25°C / Z+2	20°C 2		2	2		2	2	
	ZT / Z20 (MAX.)	Z-55°C / Z+2	20°C 4		4	3		3	3	
	the capacitors are restored to 20°C after the rated tan					Capacitance change Within ±2			je Within ±	20% of the initial capacitance value
Endurance						tan δ 200% or			200% oi	r less than the initial specified value
						Leakag	kage current Less than			n or equal to the initial specified value
Shelf Life After storing the capacitors under no load at 105°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 20°C, they shall meet the specified values for the endurance characteristics listed above.						tment based on JIS C 5101-4 clause 4.1 at				
Budden of the collection	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.					Capacitance change			Within ±10% of the initial capacitance value	
Resistance to soldering							tan δ		Less than or equal to the initial specified value	
heat						L	Leakage current		Less than or equal to the initial specified value	
Maulian	from the plate and restored to 20 C.									
Marking	Black print on the ca	ase top.								

■Chip Type



Type numbering system (Example : $16V 10\mu F$)



• Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.35	0.50	0.64	0.83	1.00

4 5 6.3 8 1.8 2.1 2.4 3.3

4.3 5.3 6.6 8.3

4.3 5.3 6.6 8.3 1.0 1.3 2.2 2.3

Α

В



■ Dimensions

Rated Voltage (V) (code)	Rated Capacitance (µF)	Case Size φDXL(mm)	tan δ	Leakage Current (µA) (at 20°C after 2 minutes)	Impedance(Ω) MAX. (20°C/100kHz)	Rated Ripple (mArms) (105°C/100kHz)	Part Number
	22	4×5.4	0.22	3	5.0	50	UWF0J220MCL1GB
	33	5×5.4	0.22	3	2.6	80	UWF0J330MCL1GB
	47	5×5.4	0.22	3	2.6	80	UWF0J470MCL1GB
6.3 (0J)	68	6.3×5.4	0.22	4.284	1.3	115	UWF0J680MCL1GB
(00)	100	6.3×5.4	0.22	6.3	1.3	115	UWF0J101MCL1GB
	150	8×6.2	0.22	9.45	0.8	150	UWF0J151MCL1GS
	220	8×6.2	0.22	13.86	0.8	150	UWF0J221MCL1GS
	22	5×5.4	0.19	3	2.6	80	UWF1A220MCL1GB
	33	5×5.4	0.19	3.3	2.6	80	UWF1A330MCL1GB
10	47	6.3×5.4	0.19	4.7	1.3	115	UWF1A470MCL1GB
(1A)	68	6.3×5.4	0.19	6.8	1.3	115	UWF1A680MCL1GB
	100	8×6.2	0.19	10	0.8	150	UWF1A101MCL1GS
	150	8×6.2	0.19	15	0.8	150	UWF1A151MCL1GS
	10	4×5.4	0.16	3	5.0	50	UWF1C100MCL1GB
	15	5×5.4	0.16	3	2.6	80	UWF1C150MCL1GB
	22	5×5.4	0.16	3.52	2.6	80	UWF1C220MCL1GB
16 (1C)	33	6.3×5.4	0.16	5.28	1.3	115	UWF1C330MCL1GB
(10)	47	6.3×5.4	0.16	7.52	1.3	115	UWF1C470MCL1GB
	68	8×6.2	0.16	10.88	0.8	150	UWF1C680MCL1GS
	100	8×6.2	0.16	16	0.8	150	UWF1C101MCL1GS
	4.7	4×5.4	0.14	3	5.0	50	UWF1E4R7MCL1GB
	6.8	4×5.4	0.14	3	5.0	50	UWF1E6R8MCL1GB
	10	5×5.4	0.14	3	2.6	80	UWF1E100MCL1GB
25	15	6.3×5.4	0.14	3.75	1.3	115	UWF1E150MCL1GB
(1E)	22	6.3×5.4	0.14	5.5	1.3	115	UWF1E220MCL1GB
	33	6.3×5.4	0.14	8.25	1.3	115	UWF1E330MCL1GB
	47	8×6.2	0.14	11.75	0.8	150	UWF1E470MCL1GS
	68	8×6.2	0.14	17	0.8	150	UWF1E680MCL1GS
	1	4×5.4	0.12	3	5.0	50	UWF1V010MCL1GB
	1.5	4×5.4	0.12	3	5.0	50	UWF1V1R5MCL1GB
	2.2	4×5.4	0.12	3	5.0	50	UWF1V2R2MCL1GB
	3.3	4×5.4	0.12	3	5.0	50	UWF1V3R3MCL1GB
Ī	4.7	4×5.4	0.12	3	5.0	50	UWF1V4R7MCL1GB
35 (1V)	6.8	5×5.4	0.12	3	2.6	80	UWF1V6R8MCL1GB
```'	10	5×5.4	0.12	3.5	2.6	80	UWF1V100MCL1GB
	15	6.3×5.4	0.12	5.25	1.3	115	UWF1V150MCL1GB
	22	6.3×5.4	0.12	7.7	1.3	115	UWF1V220MCL1GB
	33	8×6.2	0.12	11.55	0.8	150	UWF1V330MCL1GS
	47	8×6.2	0.12	16.45	0.8	150	UWF1V470MCL1GS

For taping specifications, recommended land size/soldering by reflow and minimum order quantity, please refer to the Guidelines for Aluminum Electrolytic Capacitors.
 Please select UUJ if high C/V products are required.

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35SGV220M10X10.5 35SLV10M5X6.1 VEJ220M1VTR-0606 VES2R2M1HTR-0405 50SEV10M6.3X5.5 50SGV1M4X6.1 107SML016M

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